

Upcoming: April 1–5 MRS Spring Meeting, MRS; April 5–6 MEMS Materials Issues Workshop, MRS.

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313; bulletin@mrs.org.

MRS, A-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-S, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the January 2002 MRS BULLETIN for March 2002 Calendar entries.

APRIL 2002

1–5 MRS Spring Meeting, San Francisco, CA. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

3–4 Cool Chips Conf., Monterey, CA. C. Spear, Intertech Conferences, 19 Northbrook Office Park, Portland, ME 04105; 207-781-9612; fax 207-781-2150; e-mail chuck@intertechusa.com; www.intertechusa.com.

3–5 Intl. Conf. on High-Density Interconnect and Systems Packaging, Santa Clara, CA. Intl. Microelectronics And Packaging Society, 611 2nd St. NE, Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

5–6 ▼ APS New England Section Spring Meeting, Waltham, MA. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

5–6 ▼ MEMS Materials Issues Workshop, Krakow, Poland. H. Kusiak, Dept. of Computational Methods in Metallurgy, Akademia Górniczo-Hutnicza, Mickiewicza 30, 30-059 Krakow, Poland; 48-12-617-2921; e-mail hkusiak@metal.agh.edu.pl.

8–10 Intl. Conf. on Metal Powder Deposition for Rapid Manufacturing, San Antonio, TX. S.E. Leatherman, Technical Programs Mgr., Metal Powder Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail leatherm@mpif.org; www.mpif.org.

9–11 Materials Congress 2002, London, UK. V. Morrison, IOM Communications, 1 Carlton House Terrace, London SW1Y 5DB, UK; 44-20-7451-7340; fax 44-20-7839-2289; www.materials.org.uk/congress2002/intro.htm.

10–12 ▼ 6th Intl. Polymer Bonded Magnets Conf., Chicago, IL. Intertech Conferences, 19 Northbrook Office Park, Portland, ME 04105; 207-781-9603; fax 207-781-2150; e-mail info@intertechusa.com; www.intertechusa.com.

11–12 27th AAAS Colloquium on Science and Technology Policy, Washington, DC. American Assoc. for the Advancement of Science, Science and Policy Programs, 1200 New York Ave. N.W., Washington, DC 20005; 202-326-6600; fax 202-289-4950; e-mail slita@aaas.org; www.aaas.org/spp/dspp/rd/colloqu.htm.

12–13 ▼ APS New York Section Spring Meeting, Oneonta, NY. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

12–13 ▼ APS Ohio Section Spring Meeting, Youngstown, OH. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

13–18 15th Intl. Symposium on Microscale Separations and Analysis, Stockholm, Sweden. HPCE 2002 Secretariat, The Swedish Chemical Society, Wallingatan 24, SE-111 24 Stockholm, Sweden; 46-8-411-5260; fax 46-8-10-66-78; e-mail monika@chemsoc.se.; www.chemsoc.se/sidor/KK/hpce2002/hpce2002.htm.

13–18 45th SVC Technical Conf., Lake Buena Vista, FL. Society of Vacuum Coaters, 71 Pinon Hill Place N.E., Albuquerque, NM 87122-1914; 505-856-7188; fax 505-856-6716; e-mail svcinfo@svc.org; www.svc.org.

14–17 5th Conf. on Material Forming, Krakow, Poland. H. Kusiak, Dept. of Computational Methods in Metallurgy, Akademia Górniczo-Hutnicza, Mickiewicza 30, 30-059 Krakow, Poland; 48-12-617-2921; e-mail hkusiak@metal.agh.edu.pl.

17–19 IMAPS Intl. Conf. on Electronics Packaging and 16th Microelectronics Show, Tokyo, Japan. Intl. Microelectronics and Packaging Society, 611 2nd St. N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

20–23 APS April Meeting, Albuquerque, NM. American Physical Society, 1 Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

21–26 Conf. on High-Power Laser Ablation, Taos, NM. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

22–24 ▼ AAPS Pharmaceuticals and Drug Delivery Conf., Arlington, VA. American Assoc. of Pharmaceutical Scientists, 2107 Wilson Blvd., Ste. 700, Arlington, VA 22201-3046; 703-243-2800; fax 703-243-9532; e-mail meetings@aaps.org; www.aaps.org.

22–25 Intl. Conf. on Computational Nano Science, and Modeling and Simulation of Microsystems, San Juan, Puerto Rico. ICCN-MSM, 696 San Ramon Valley Blvd., Ste. 423, Danville, CA 94526-4022; 925-743-9466; fax 509-696-6416; e-mail wenning@cr.org; www.cr.org/MSM2002/register.html.

25–26 ▼ AAPS Workshop on Chemical and Physical Form Selection of Drug Candidates: Principles, Considerations, and Case Studies, Arlington, VA. American Assoc. of Pharmaceutical Scientists, 2107 Wilson Blvd., Ste. 700, Arlington, VA 22201-3046; 703-243-2800; fax 703-243-9532; e-mail meetings@aaps.org; www.aaps.org.

28–1 104th ACerS Annual Meeting, St. Louis, MO. The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.ceramics.org.

28–2 InterMag Europe Conf. of the IEEE Magnetics Society, Amsterdam, The Netherlands. InterMag Europe 2002, Courtesy Associates, 2025 M St. N.W., Ste. 800, Washington, DC 20036; 202-973-8676; fax 202-973-8722; e-mail intermag@courtesyassoc.com; www.intermagconference.com.

28–2 ▼ Intl. Symposium on Structural Intermetallics, Jackson Hole, WY. The Minerals, Metals & Materials Society, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-900; fax 724-776-3770; e-mail mtgsrv@tms.org; www.tms.org.

28–3 Conf. on High-Performance Powder Metallurgy Components, Coimbra, Portugal. United Engineering Foundation, 27th Floor, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

29–30 IMAPS Technology Workshop on Ceramic Applications for Microwave and Photonic Packaging, Providence, RI. Intl. Microelectronics and Packaging Society, 611 2nd St. N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

29–2 Intl. Conf. on Characterization and Metrology for ULSI Technology, Gaithersburg, MD. L. Printz, NIST, Gaithersburg, MD 20899; e-mail lori.printz@nist.gov; www.eeel.nist.gov/812/conference. **Endorsed.**

MAY 2002

2–3 ▼ IMAPS Advanced Technology Workshop on Ceramic Applications for Microwave and Photonic Packaging, Providence, RI. Intl. Microelectronics and Packaging Society, 611 2nd St. N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

5–8 8th Magneto-Optical Recording Intl. Symposium, Bénédict, Brittany, France. MORIS'2002 Secretariat, c/o N. Keller, LMOV—Univ. of Versailles/CNRS, 45 Ave. des Etats-Unis, 78035 Versailles Cedex, France; 33-139-25-4670; fax 33-139-25-4652; e-mail moris2002@physique.uvsq.fr; www.univ-brest.fr/moris2002.

6–7 Intl. Conf. on Functionally Graded Materials, Denver, CO. S. Leatherman, Technical Programs Mgr., Metal Power Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail leatherm@mpif.org; www.mpif.org.

6–10 ▼ Activated Carbon Workshop, Pittsburgh, PA. Professional Analytical and Consulting Services, Inc., 409 Meade Dr., Coraopolis, PA 15108-9616; 724-457-6576; e-mail HNPacs@aol.com; www.pacslabs.com.

12–16 SAMPE Conf. on Affordable Material Technology—Platform to Global Value and Performance, Long Beach, CA. D. Weaver, SAMPE Business Office, P.O. Box 2459, Covina, CA 91722; 626-331-0616; fax 626-332-8929; e-mail dweaveribo@cs.com; www.sampe.org.

12–17 201st Meeting of the Electrochemical Society, Philadelphia, PA. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org.

17–18 ▼ APS Northwest Section Meeting, Edmonton, Alberta, Canada. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

18–21 ▼ ACerS Structural Clay Products Division Meeting, Augusta, GA. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrv@acers.org; www.ceramics.org.

19–23 11th Intl. Conf. on Electron Microscopy of Solids, Krynica, Poland. Polish Academy of Sciences, Inst. of Metallurgy and Materials Science, 30-059 Cracow, Reymonta St. 25, Poland; fax 48-12-637-2192; e-mail emc2002@imim-pan.krakow.pl; www.imim-pan.krakow.pl/emc2002.

19–24 ▼ Conf. on Lasers and Electro-Optics/Quantum Electronics and Laser Science, Long Beach, CA. CLEO/QELS Conf. Mgr., c/o Optical Society of America, 2010 Massachusetts Ave., N.W., Washington, DC 20036; 202-416-1907; fax 202-416-6100; e-mail cust.serv@osa.org; www.osa.org/CLEO.

19–24 ▼ Society for Information Display Annual Symposium, Boston, MA. M. Goldfarb, Palisades Convention Mgmt., 411 Lafayette St., 2nd Floor, New York, NY 10003; 212-460-8090; fax 212-460-5460; e-mail mgoldfarb@pcm41.com; www.sid.org.

20–22 ▼ Surface Analysis Conf., Nashville, TN. B.R. Rogers, Dept. of Chemical Engineering, Vanderbilt Univ., VUStation B 351604, Nashville, TN 37235-1604; 615-343-3269; fax 615-343-7951; e-mail bridget.rogers@vanderbilt.edu; http://people.vanderbilt.edu/~bridget.rogers.

20–23 European Workshop on Smart Structures in Engineering and Technology, Giens, France. A. Mitchell, Workshop Secretary, Univ. of Strathclyde, Dept. of Electronic and Electrical Engineering, 204 Royal College Bldg., George St., Glasgow, G1 1XW, UK; 44-141-548-2543; fax 44-141-553-1955; e-mail a.mitchell@eee.strath.ac.uk; www.assetnet.org.

22–25 Intl. Conf. on Nuclear Structure: Mapping the Triangle, Grand Teton Natl. Park, WY. L. Riedinger, Oak Ridge Natl. Lab.; 865-574-4321; fax 865-574-8225; e-mail triangle@ornl.gov; http://wnsl.physics.yale.edu/icns2002.

24-28 APS Div. of Particles and Fields Meeting, *Williamsburg, VA*. DPF2002, Dept. of Physics, College of William and Mary, Williamsburg, VA 23187-8795; 757-221-3538; fax 757-221-3540; e-mail dpf2002@physics.wm.edu; http://www.dpf2002.org.

25-26 Conf. on Synchrotron Radiation: Earth, Environmental, and Materials Sciences Applications, *Saskatoon, Saskatchewan, Canada*. G.S. Henderson, Mineralogical Assoc. of Canada, P.O. Box 78087, 1460 Merivale Rd., Ottawa, Ontario K2E 1B1, Canada; phone and fax 613-226-4651; e-mail henders@geology.utoronto.ca; www.mineralogicalassociation.ca.

25-30 American Crystallographic Assoc. Annual Meeting, *San Antonio, TX*. American Crystallographic Assoc., P.O. Box 96 Ellicott Station, Buffalo, NY 14205-0096; 716-856-9600; fax 716-852-4846; e-mail aca@hwi.buffalo.edu; www.hwi.buffalo.edu/aca.

27-29 7th European Symposium on Polymer Blends, *Lyon-Villeurbanne, France*. Secretariat, 7th European Symposium on Polymer Blends, Lab. des Matériaux Macromoléculaires, Bat J. Verne, INSA Lyon, 20 Ave. Albert Einstein, 69621, Villeurbanne Cedex, France; 33-4-72-43-8527; e-mail polymerblends@insa-lyon.fr; www.insa-lyon.fr/polymer_blends/index.htm.

27-31 Intl. Congress on Laser Advanced Materials Processing, *Osaka, Japan*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

JUNE 2002

2-6 Intl. Conf. on Applications of Photonic Technology, *Quebec City, Canada*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

3-7 9th Intl. Conf. on Moon Spin Rotation, Relaxation, and Resonance, *Williamsburg, VA*. C.E. Stronach, Conf. Chair, Physics Dept., P.O. Box 9325, Virginia State Univ., Petersburg, VA 23806; 804-524-5915; fax 804-524-5439; e-mail cstronac@vsu.edu; http://moon.physics.wm.edu/~musr2002.

3-7 11th Intl. Conf. on Metal Organic Vapor Phase Epitaxy, *Berlin, Germany*. IC MOVPE XI Conf. Office, TU Berlin Servicegesellschaft mbH, c/o Technische Univ. Berlin, Steinplatz 1, D-10623 Berlin, Germany; fax 49-30-314-24087; e-mail office@icmovpe-2002.de; www.icmovpe-2002.de.

5-8 4th Intl. Conf. on Mechanics and Materials in Design, *Nagoya, Japan*. H. Fujii, Dept. of Mechanical Engineering, Gifu Univ., Japan; e-mail fujiih@mech.gifu-u.ac.jp.

8-13 39th Clay Minerals Society Annual Meeting, *Boulder, CO*. K. Nagy, Dept. of Geological Sciences, Univ. of Colorado, Boulder, CO 80309; 303-492-6187; fax 303-492-2602; e-mail kathryn.nagy@colorado.edu; www.colorado.edu/geolsci/cms.

9-13 Conf. on Nanostructured Advanced Magnetic Materials, *Irsee, Germany*. United Engineering Foundation, 27th Floor, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

10-12 4th Intl. Conf. on Materials for Microelectronics and Nanoengineering, *Espoo, Finland*. L. Bromley, Conferences and Events, IOM Communications; 44-20-7451-7302; fax 44-20-7839-2289; e-mail lisa_bromley@materials.org.uk.

10-14 8th Intl. Conf. on Electronic Materials, *Xi'an, China*. J. Cheng; 86-10-6894-4280; fax 86-10-6842-8640; e-mail cmrsec@public.bta.net.cn; www.c-mrs.org.cn/icem2002.

C-MRS/IUMRS.

16-18 European IMAPS Symposium, *Cracow, Poland*. Intl. Microelectronics And Packaging Society, 611 2nd St. NE, Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

16-20 Intl. Cryogenic Materials Conf., *Xi'an, China*. Y. Feng, Northwest Inst. for Non-ferrous Metal Research, P.O. Box 51, Xi'an, Shaanxi 710016, China; 86-29-623-1079; fax 86-29-623-1103; e-mail smrc@pub.xaonline.com.

16-21 6th Intl. Conf. on Nanostructured Materials, *Orlando, FL*. K. Finnerty, Conf. Secretary, Dept. of Ceramic and Materials Engineering, Rutgers Univ., 607 Taylor Rd., Piscataway, NJ 08854; 732-445-2245; fax 732-445-5977; e-mail kfinnert@rci.rutgers.edu; www.nano2002.com.

16-21 Powder Metallurgy and Particulate Materials World Congress, *Orlando, FL*. S. Leatherman, Metal Powder Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6992; 609-452-7700; fax 609-987-8523; e-mail leatherm@mpif.org; www.mpif.org.

17-20 1st Intl. Conf. on Multiscale Materials Modeling, *London, UK*. MMM Local Organising Committee, Dept. of Materials, Queen Mary, Univ. of London, London E1 4NS, UK; 44-20-7882-5159; fax 44-20-9881-9804; e-mail x.guo@qmul.ac.uk; www.multiscalemodelling.com.

18-21 E-MRS Spring Meeting, *Strasbourg, France*. E-MRS, 23 rue du Loess, B.P. 20, 67037 Strasbourg Cedex 02, France; 33-3-8810-6372; fax 33-3-8810-6343; e-mail emrs@phase.c-strasbourg.fr; www-emrs.c-strasbourg.fr. **E-MRS.**

19-21 5th European Workshop on Low-Temperature Electronics, *Grenoble, France*. WOLTE-5, LPCS-IMEP, ENSERG, B.P. 257, 38016 Grenoble Cedex 1, France; fax 33-476-85-60-70; e-mail balestra@enserg.fr.

19-21 IMAPS Advanced Technology Workshop on Passive Integration, *Ogunquit, ME*. Intl. Microelectronics and Packaging Society, 611 2nd St. N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

22-28 Intl. Quantum Electronics Conf., collocated with Conf. on Lasers, Applications, and Technologies, *Moscow, Russia*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

23-26 Intl. Conf. on Thermomechanical Processing, *Sheffield, UK*. Thermomechanical Processing: Mechanics, Microstructure, and Control, c/o IMPETUS Admin. Office, Univ. of Sheffield, Sir Frederick Mappin Bldg., Mappin St., Sheffield S1 3JD, UK; 44-114-222-6018; fax 44-114-222-6015; e-mail tpmmc@sheffield.ac.uk; http://dyn052176.shef.ac.uk/conference_2002.

23-27 6th Intl. Conf. on Computer Simulation of Radiation Effects in Solids, *Dresden, Germany*. COSIRES2002, c/o Forschungszentrum Rossendorf e.V., Inst. of Ion Beam Physics and Materials Research, P.O. Box 510119, 01314 Dresden, Germany; fax 48-351-260-3285; e-mail COSIRES2002@fz-rossendorf.de; www.fz-rossendorf.de/FWI/COSIRES2002.

23-27 American Conf. on Neutron Scattering, *Knoxville, TN*. R.M. Briber, Dept. of Materials and Nuclear Engineering, 2100 Marie Mount Hall, Univ. of Maryland, College Park, MD 20742-7531; 301-405-7313; fax 301-314-9601; e-mail rbriber@eng.umd.edu; www.sns.gov/acns.

23-28 11th Intl. Meeting on Lithium Batteries, *Monterey, CA*. IMLB 11 Conf. Secretariat, c/o The Electrochemical Society, Inc., 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org/meetings/011/imlb11.html.

24-26 60th Annual Device Research Conf., *Santa Barbara, CA*. The Minerals, Metals & Materials Society, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-900; fax 724-776-3770; e-mail mtgsrv@tms.org; www.tms.org/Meetings/Specialty/DRC/2002/DRC-2002-Home.html.

24-26 AAPS Natl. Biotechnology Conf., *San Diego, CA*. American Assoc. of Pharmaceutical Scientists, 2107 Wilson Blvd., Ste. 700, Arlington, VA 22201-3046; 703-243-2800; fax 703-243-9532; e-mail meetings@aaps.org; www.aaps.org.

24-26 IMAPS Topical Workshop on Flip Chip Technology, *Austin, TX*. Intl. Microelectronics and Packaging Society, 611 2nd St. N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

24-27 Natl. Space and Missile Materials Symposium, *Colorado Springs, CO*. NSMMS, Anteon Corp., 5100 Springfield St., Ste. 509, Dayton, OH 45431-1264; fax 937-253-2296; e-mail mkubal@anteon.com; www.usasymposium.com.

26-28 Electronic Materials Conf., *Santa Barbara, CA*. TMS Meetings Services, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/meetings.

30-5 3rd Intl. Alloy Conf., *Estoril (Lisbon), Portugal*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

JULY 2002

1-3 World Textile Conf.: Textile Engineering at the Dawn of a New Millennium, *Bruges, Belgium*. 32-9-2645750; fax 32-9-2645846; e-mail Sylvie.Bauwens@rug.ac.be.

1-5 Conf. on Coatings Science and Technology, *Athens, Greece*. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail info@ims-np.org; http://ims-np.org.

1-5 Intl. Conf. on Fuel Cells, *Lucerne, Switzerland*. European Fuel Cell Forum, P.O. Box 99, CH-5452 Oberrohrdorf, Switzerland; 41-56-496-7292; fax 41-56-496-4412; e-mail info@efcf.com; www.efcf.com.

7-11 47th Annual SPIE Meeting, *Seattle, WA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

7-12 7th Intl. Workshop on Positron and Positronium Chemistry, *Knoxville, TN*. S. Lantz, PPC7, Oak Ridge Natl. Lab., P.O. Box 2008, M.S. 6142, Oak Ridge, TN 37831; 865-574-4882; fax 865-574-8363; e-mail Sharon.Lantz@ornl.gov; www.ornl.gov/ppc.

8-12 13th Intl. Conf. on Internal Friction and Ultrasonic Attenuation in Solids, and 1st Scientific Exhibition on Mechanical Spectroscopy Equipment, *Bilbao, Spain*. J. San Juan, Dept. Fisica de la Materia Condensada, Facultad de Ciencias, Univ. del País Vasco, UPV-EHU, Apdo. 644-48080, Bilbao, Spain; 34-94-601-2478; fax 34-94-464-8500; e-mail icifuas@lg.ehu.es; http://icifuas.ehu.es.

11-12 Conf. on Industry-University Partnership in Materials Engineering, *London, UK*. D. Greenaway, Conf. and Events, IOM Communications; 44-20-7451-7324; fax 44-20-7839-2289; e-mail Doreen.Greenaway@materials.org.uk; www.materials.org.uk/iomevents/industry-univ.

14-18 13th Intl. Symposium on Transport Phenomena, *Victoria, BC, Canada*. S. Dost, ISTEP-13, Dept. of Mechanical Engineering, Univ. of Victoria, Victoria, BC, Canada V8W 3P6; 250-721-8898; fax 250-721-6294; e-mail istp13@uvic.ca; www.istp13.uvic.ca.

14-19 10th Intl. Conf. on the Physics and Chemistry of Ice, *St. John's, Newfoundland, Canada*. Conf. Office, Rm. 315 Hatcher House, Memorial Univ. of Newfoundland, St. John's, NF Canada A1B 3P7; 709-737-7657; fax 709-737-3520; e-mail Stephen.Jones@nrc.ca; www.housing.mun.ca/conf/pci.

14-19 CIMTEC Intl. Conf. on Materials and Technologies: 10th Intl. Ceramics Congress and 3rd Forum on New Materials, *Florence, Italy*. CIMTEC 2002 Secretariat, P.O. Box 174, 48018 Faenza, Italy; 39-546-22461; fax 39-546-664138; www.dinamica.it/cimtec.

14-19 Conf. on Polymer Colloids: Preparation and Properties of Aqueous Polymer Dispersions, *Irsee, Germany*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

14-25 3rd Intl. Wilhelm and Else Heraeus Summerschool: Photonic Crystals, *Wittenberg, Germany*. R. Wehrspohn, Max-Planck Inst. für Mikrostrukturphysik, Weinberg 2, 06108 Halle, Saale, Germany; 49-345-558-2726; fax 49-345-551-1223; e-mail wehrspoh@mpi-halle.de; www.photonische-kristalle.de/summerschool.

15-19 11th Intl. Congress on Plasma Physics, *Sydney, Australia*. I. Falconer, Conf. Secretary, School of Physics, Univ. of Sydney, Sydney NSW 2006, Australia; 61-2-9351-2599; fax 61-2-9692-0923; e-mail i.falconer@physics.usyd.edu.au; www.ise.canberra.edu.au/ICPP2002.

17-19 Intl. Conf. on Smart Materials, Structures, and Systems, *Bangalore, India*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

21-26 4th World Congress on Particle Technology, *Sydney, Australia*. J. Hatte, Conf. Coordinator, ICMS Australasia Pty Ltd., Level 6, 2 Bridge St., Sydney NSW 2000, Australia; 61-2-9241-1478; fax 61-2-9251-3552; e-mail josie@icmsaust.com.au; www.wcpt4.com.

21-26 8th Intl. Conf. on New Diamond Science and Technology, *Melbourne, Australia*. B. Hewitt, Conf. Mgmt., Old Physics Bldg., Univ. of Melbourne, Parkville 3010, Victoria, Australia; 61-3-8344-6389; fax 61-3-8344-6122; e-mail icndst-8@unimelb.edu.au; www.conferences.unimelb.edu.au/icndst-8.

22-25 Intl. Workshop on Nitride Semiconductors, *Aachen, Germany*. IWN 2002 Secretariat, Forschungszentrum Jülich GmbH, Conf. Service, 52425 Jülich, Germany; 49-24-6161-3833; fax 49-24-6161-5333; e-mail iwn2002@fz-juelich.de; www.fz-juelich.de/iwn2002.

22-26 Intl. Conf. on Solvo-Thermal Reactions, *East Brunswick, NJ*. R.E. Riman, ICSTR 2002 Executive Committee, Dept. of Ceramic and Materials Engineering, College of Engineering, Rutgers Univ., 607 Taylor Rd., Piscataway, NJ 08854-8065; 732-445-4946; fax 732-445-6262; e-mail riman@rci.rutgers.edu; www.ICSTR.rutgers.edu.

24-4 NATO Advanced Study Inst. on Synthesis, Functional Properties, and Applications of Nanostructures, *Crete, Greece*. T. Tsakalakos, Dept. of Ceramic and Materials Engineering, College of Engineering, Rutgers Univ., 607 Taylor Rd., Piscataway, NJ 08854; 732-445-2888; fax 732-445-3229; e-mail tsakalak@rci.rutgers.edu; http://web.rutgers.edu/nanostructures.

29-2 26th Intl. Conf. on the Physics of Semiconductors, *Edinburgh, Scotland*. Conf. Dept., ICPS2002, Inst. of Physics, 76 Portland Place, London W1B 1NT, England; 44-20-7470-4800; fax 44-20-7470-4900; www.icps2002.org.

29-2 51st Denver X-Ray Conf., *Colorado Springs, CO*. D. Flaherty, Conf. Coordinator, Intl. Centre for Diffraction Data, 12 Campus Blvd., Newtown Square, PA 19073-3273; 610-325-9814; fax 610-325-9823; e-mail dxc@icdd.com; www.dxcicdd.com.

AUGUST 2002

1-2 Intl. Workshop on Processing and Applications of Superconductors, *Gatlinburg, TN*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

4-8 14th American Conf. on Crystal Growth and Epitaxy, *Seattle, WA*. T. Gentile, Conf. Secretariat, P.O. Box 3233, Thousand Oaks, CA 91359-0233; 805-492-7047; fax 805-492-4062; e-mail aacg@lafn.org; www.crystalgrowth.org.

4-9 Applied Superconductivity Conf., *Houston, TX*. Centennial Conferences, 4800 Baseline Rd., Ste. A-112, Boulder, CO 80303; 303-499-2299; fax 303-499-2599; e-mail asc@centennialconferences.com; www.ascinc.org.

18-21 Intl. Workshop on Nanostructures for Electronics and Optics, *Dresden, Germany*. NEOP, Research Ctr. Rossendorf, Inst. of Ion Beam Physics and Materials Research, P.O.B. 51 01 19, Dresden 01314, Germany; fax 49-351-260-3285; e-mail info@NEOP.de; www.NEOP.de.

18-23 Intl. Conf. on Electrophoretic Deposition: Fundamentals and Applications, *Banff, Canada*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

20-27 23rd Intl. Conf. on Low-Temperature Physics, *Hiroshima, Japan*. Japan Convention Services, Inc., LT23, Nippon Press Ctr., Bldg., 2-2-1, Uchisaiwaicho, Chiyodaku, Tokyo 100-0011, Japan; 81-3-3508-1214; e-mail lt23@convention.co.jp; www.issp.u-tokyo.ac.jp/lt23.

25-28 8th Electroceramics Conf., *Rome, Italy*. E. Di Bartolomeo, Dip. Scienze e Tecnologie Chimiche, Univ. di Roma Tor Vergata; Via della Ricerca Scientifica 1, 00133 Roma, Italy; fax 39-06-7259-4328; e-mail electroceram@stc.uniroma2.it; www.uniroma2.it/eventi/electroceramics. **Endorsed.**

25-29 Conf. on Fluid Particle Interactions, *Barga, Italy*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

25-30 11th Intl. Conf. on Rapidly Quenched and Metastable Materials, *Oxford, UK*. P. Schumacher, Dept. of Materials, Oxford Univ., Parks Rd., Oxford OX1 3PH, UK; 44-1234-378862; fax 44-1234-376219; e-mail rq11@materials.ox.ac.uk; www.materials.ox.ac.uk/rq11.

28-31 2nd Intl. Mould & Die Making and Manufacturing Technology Exhibition for Asia, *Hong Kong*. Business and Industrial Trade Fairs Ltd., Unit 1223, HITEC, 1 Trademart Dr., Kowloon Bay, Hong Kong; 852-2865-2633; fax 852-2866-1770; e-mail enquiry@bitf.com.hk.

SEPTEMBER 2002

4-5 Conf. on 42 Volt Automotive Systems: Exploring the Market and Opportunities in Bringing 42 Volts to Market, *Cleveland, OH*. B. Santos, Intertech Conferences, 19 Northbrook Office Park, Portland, ME 04105; 207-781-9800; fax 207-781-2150; e-mail bsantos@intertechusa.com; www.intertechusa.com/42volts.html.

4-6 35th Intl. Symposium on Microelectronics, *Denver, CO*. Intl. Microelectronics And Packaging Society, 611 2nd St. NE, Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

8-12 6th Intl. Meeting on Magnetic Resonance in Porous Media, *Ulm, Germany*. www.uni-ulm.de/nmr/mrpm6/early_notification.htm.

9-13 8th Intl. Conf. on Plasma and Surface Engineering, *Garmisch-Partenkirchen, Germany*. Arbeitskreis Plasmaoberflächentechnologie (PISE Germany), c/o. K. Reichel, VDI-Technologiezentrum, Graf-Recke-Str. 84, D-40239 Düsseldorf, Germany; 49-211-6214-567; fax 49-211-6214-484; e-mail akplasma@vdi.de; www.akplasma.org.

10-12 Intl. Conf. on Design and Nature: Comparing Design in Nature with Science and Engineering, *Udine, Italy*. G. Cossutta, Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail gcossutta@wessex.ac.uk; www.wessex.ac.uk.

16-20 Intl. Conf. on Shot Peening, *Garmisch-Partenkirchen, Germany*. P. Schepp, Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-7917-750; fax 49-69-7917-733; e-mail shot-peening@dgm.de; www.dgm.de/shot-peening.

17-20 A First Materials Forum on Future Sustainable Technologies, *Augsburg, Germany*. e-mail stritzker@physik.uni-augsburg.de. **E-MRS/MRS.**

22-26 3rd World Congress on Microwave and Radio Frequency Processing, *Sydney, Australia*. e-mail mrf2002@tourhosts.com.au; www.microwave-rf.org.

24-27 3rd World Congress on Emulsions, *Lyon, France*. CME, 50 Place Marcel Pagnol, 92100 Boulogne-Billancourt, France; 33-147-617-689; fax 33-147-617-465; e-mail alain.lecoroller@wanadoo.fr; www.cme-emulsion.com.

24-28 7th Intl. Conf. on Semi-Solid Processing of Alloys and Composites, *Tsukuba, Japan*. M. Kiuchi, 7th S2P Secretariat, KIL-AMETEC, Rm. 703, 5-30-1 Shiba, Minato-ku, Tokyo 108-0014, Japan; fax 81-3-5730-3136; e-mail s2p7@jstp.or.jp; www.s2p7@jstp.or.jp.

26-27 10th Intl. Activated Carbon Conf., *Pittsburgh, PA*. Professional Analytical and Consulting Services, Inc., 409 Meade Dr., Coraopolis, PA 15108-9616; 724-457-6576; e-mail HNpacs@aol.com; www.pacslabs.com.

29-2 18th Laser Science Conf., *Orlando, FL*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

29-2 IMAPS Nordic Conf., *Stockholm, Sweden*. Intl. Microelectronics and Packaging Society, 611 2nd St. N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; e-mail info@imapsnordic.org; www.imapsnordic.org.

30-2 Materials Week Congress, and 5th Intl. Trade Fair for Materials Applications, Surface Technology, and Product Engineering, *Munich, Germany*. E. Richter-Maierhofer, Materialca, Messe München GmbH, 81823 München, Germany; 49-89-949-20650; fax 49-89-949-20659; e-mail richter-maierhofer@messe-muenchen.de; www.materialca.de.

OCTOBER 2002

1-3 Advanced Metallization Conference 2002, *San Diego, CA*. Continuing Education in Engineering, UC Berkeley Extension, 1995 University Ave., Berkeley, CA 94720-7010; 510-642-4151; fax 510-642-6027; e-mail course@unx.berkeley.edu; www.unex.berkeley.edu/eng/metal.

1-4 54th Pacific Coast Regional and ACerS Basic Science Div. Meeting, *Seattle, WA*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 619-899-6109; e-mail customersvc@acers.org; www.ceramics.org.

4-5 APS Four Corners Section Meeting, *Salt Lake City, UT*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

6-10 TMS Fall Meeting, *Columbus, OH*. TMS Programming Dept., 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail ckobert@tms.org; www.tms.org.

8-11 IMAPS Topical Workshop on Optoelectronics Packaging and Micro-Optoelectromechanical Systems, *Bethlehem, PA*. Intl. Microelectronics and Packaging Society, 611 2nd St. N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

10-12 APS Texas Section Meeting, *Brownsville, TX*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

11-12 APS New York Section Fall Meeting, *Syracuse, NY*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

13-16 ACerS Glass and Optical Materials Div. Meeting, *Pittsburgh, PA*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 619-899-6109; e-mail customersrvc@acers.org; www.ceramics.org.

14-17 21st Intl. Congress on Applications of Lasers and Electro-Optics, *Scottsdale, AZ*. B. Cohen, Laser Inst. of America, 13501 Ingenuity Dr., Ste. 128, Orlando, FL 32826; 407-380-1553; fax 407-380-5588; e-mail bcohen@laserinstitute.org; www.icaleo.org.

15-18 55th Gaseous Electronics Conf., *Minneapolis, MN*. E-mail gec@me.umn.edu; www.me.umn.edu/gec.

16-18 7th Spanish Natl. Materials Conf., *Madrid, Spain*. O. Sanz, Sociedad Espanola de Ceramica y Vidrio; 34-918-711-800; fax 34-918-700-500; www.secv.es/madridmateriales2002.

16-18 ACerS Refractory Ceramics Division and Pittsburgh Section Fall Meeting, *Pittsburgh, PA*. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customerstvc@acers.org; www.ceramics.org.

17-18 9th Sampling, On-Site Analysis, and Sample Preparation Conf., *Pittsburgh, PA*. Professional Analytical and Consulting Services, Inc., 409 Meade Dr., Coraopolis, PA 15108-9616; 724-457-6576; e-mail HNPacs@aol.com; www.pacslabs.com.

18-19 APS Ohio Section Fall Meeting, *Columbus, OH*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

20-25 202nd Meeting of the Electrochemical Society, *Salt Lake City, UT*. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org.

21-24 8th Symposium on Temperature: Its Measurement and Control in Science and Industry, *Chicago, IL*. D.N. Dunkley, 8th Symposium on Temperature, ISA, P.O. Box 12277, 67 Alexander Dr., Research Triangle, NC 12277; e-mail ddunkley@isa.org.

24-26 2nd Intl. Conf. on Shaping of Advanced Ceramics, *Ghent, Belgium*. 32-14-335607; e-mail greet.meyen@vito.be.

29-3 ABET Annual Meeting, *Pittsburgh, PA*. 2002 ABET Annual Meeting, 11 Market Place, Ste. 1050, Baltimore, MD 21202-4012; www.abet.org.

30-2 APS Southeast Section Meeting, *Auburn, AL*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

NOVEMBER 2002

5-7 14th IAS Rolling Conf., 1st IAS Conf. on Uses of Steel, and 4th ISS Argentina Section Meeting, *Buenos Aires, Argentina*. C. Genzano, Inst. Argentino de Siderurgia, Av. Central y Calle 19 Oeste, 2900 San Nicolás, Pcia. de Buenos Aires, Argentina; 54-3461-460803; fax 54-3461-462989; e-mail genzano.ias@cablenet.com.ar; www.cablenet.com.ar/ias/semlaminacion.htm.

10-14 AAPS Annual Meeting, *Toronto, Ontario, Canada*. American Assoc. of Pharmaceutical Scientists, 2107 Wilson Blvd., Ste. 700, Arlington, VA 22201-3046; 703-243-2800; fax 703-243-9532; e-mail meetings@aaps.org; www.aaps.org.

11-15 44th Annual Meeting of the APS Division of Plasma Physics, *Orlando, FL*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

12-16 17th Intl. Conf. on the Application of Accelerators in Research and Industry, *Denton, TX*. J.L. Duggan, Univ. of North Texas, Denton, TX 76203-1427; 940-565-3250; fax 940-565-2227; e-mail jduggan@unt.edu; http://orgs.unt.edu/CAARI.

20-21 Symposium in Memory of Dr. Bernie Miller, *Princeton, NJ*. Course Registrar, TRI/Princeton, 601 Prospect Ave., Princeton, NJ 08540; 609-430-4820; fax 609-683-7149; e-mail info@triprinceton.org; www.triprinceton.org/miller.

24-26 APS Division of Fluid Dynamics Meeting, *Dallas, TX*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

DECEMBER 2002

2-6 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

7-11 EUCHEM Conf. on Molecular Tribology, *Märsta, Sweden*. Molecular Tribology, The Swedish Natl. Committee for Chemistry, Wallingatan 24 3tr, SE-111 24 Stockholm, Sweden; 46-8-411-52-60; fax 46-8-10-66-78; e-mail anna@chemsoc.se; www.chemsoc.se.

MARCH 2003

2-6 TMS Annual Meeting, *San Diego, CA*. Programming Dept., The Minerals, Metals & Materials Society, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-900; fax 724-776-3770; e-mail cckobert@tms.org.

31-3 Conf. on Microscopy of Semiconducting Materials, *Cambridge, UK*. The Inst. of Physics, 76 Portland Place, London W1B 1NT, UK; 44-207-470-4800; e-mail conferences@iop.org.

APRIL 2003

21-25 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

JUNE 2003

9-13 E-MRS Spring Meeting, *Strasbourg, France*. E-MRS, 23 rue du Loess, B.P. 20, 67037 Strasbourg Cedex 02, France; 33-3-8810-6372; fax 33-3-8810-6343; e-mail emrs@phase.c-strasbourg.fr; www.emrs.c-strasbourg.fr. **E-MRS.**

29-4 16th Intl. Conf. on Ion Beam Analysis, *Albuquerque, NM*. B. Doyle, Sandia Natl. Laboratories, P.O. Box 5800, Albuquerque, NM 87185; 505-844-7568; fax 505-844-7775; e-mail bidoyle@sandia.gov. **Endorsed.**

JULY 2003

10-14 Thermec 2003 Intl. Conf., *Madrid, Spain*. T. Chandra, Faculty of Engineering, Univ. of Wollongong, Wollongong 2522, Australia; 61-242-213-008; fax 61-242-214-921.

AUGUST 2003

31-5 16th Intl. Mass Spectrometry Society Conf., *Edinburgh, Scotland*. A. Upton, Secretary to the 16th IMSC Organizing Committee, Orchard House, 172 High Street Yelling, St. Neots, PE19 6SD, UK; 44-1480-88-0069; fax 44-1480-88-059; e-mail imscEdinburgh@btinternet.com; www.imsc-edinburgh2003.com.

DECEMBER 2003

1-5 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

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